

P-Channel 12-V (D-S) MOSFET

PRODUCT SUMMARY								
V _{DS} (V)	$R_{DS(on)}$ (Ω)	I _D (A)	Q _g (Typ.)					
- 12	0.029 at $V_{GS} = -4.5 \text{ V}$	- 12 ^a						
	$0.034 \text{ at V}_{GS} = -2.5 \text{ V}$	- 12 ^a	23 nC					
	0.044 at V _{GS} = - 1.8 V	- 12 ^a	23110					
	0.100 at V _{GS} = - 1.5 V	- 3						

PowerPAK SC-70-6L-Single 2.05 mm

Ordering Information:

2.05 mm

SiA413DJ-T4-GE3 (Lead (Pb)-free and Halogen-free) SiA413DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

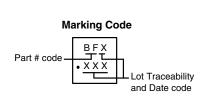
- TrenchFET[®] Power MOSFET
- New Thermally Enhanced PowerPAK® SC-70 Package
 - Small Footprint Area
 - Low On-Resistance
- · Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

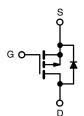


HALOGEN FREE

APPLICATIONS

Load Switch, PA Switch and Battery Switch for Portable **Devices**





P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$S (T_A = 25 ^{\circ}C, \text{ unle})$	ess otherwise no	oted)	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V_{DS}	- 12	V
Gate-Source Voltage		V_{GS}	± 8	v
	T _C = 25 °C		- 12 ^a	
Continuous Drain Current (T ₁ = 150 °C)	T _C = 70 °C	I_	- 12 ^a	
Continuous Diain Current (1) = 130 C)	T _A = 25 °C	I _D	- 10 ^{b, c}	
	T _A = 70 °C		- 8 ^{b, c}	A
Pulsed Drain Current	•	I _{DM}	- 40	
Continuous Source-Drain Diode Current	T _C = 25 °C	l _a	- 12 ^a	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S —	- 2.9 ^{b, c}	
	T _C = 25 °C		19	
Maximum Power Dissipation	T _C = 70 °C	P _D	12	W
Maximum Fower Dissipation	T _A = 25 °C	' D	3.5 ^{b, c}	VV
	T _A = 70 °C		2.2 ^{b, c}	
Operating Junction and Storage Temperature Ra	ange	T _J , T _{stg}	- 55 to 150	°C
Soldering Recommendations (Peak Temperatur	e) ^{d, e}		260	

THERMAL RESISTANCE RATINGS									
Parameter		Symbol	Typical	Maximum	Unit				
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R_{thJA}	28	36	°C/W				
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	5.3	6.5]				

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 80 °C/W.

Document Number: 70447 S12-1141-Rev. D, 21-May-12

For more information please contact: pmostechsupport@vishay.com



SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)										
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit				
Static										
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 12			V				
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 11		mV/°C				
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1β = 200 μ/		2.7		IIIV/ C				
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	- 0.4		- 1	V				
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA				
Zero Gate Voltage Drain Current	lace	$V_{DS} = -12 \text{ V}, V_{GS} = 0 \text{ V}$		- 1						
Zero date voltage Diam Current	IDSS	V_{DS} = - 12 V, V_{GS} = 0 V, T_{J} = 55 °C			- 10	μΑ				
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 5 V, V_{GS} = - 4.5 V	- 20			Α				
		V _{GS} = - 4.5 V, I _D = - 6.7 A		0.024	0.029	1				
	В	$V_{GS} = -2.5 \text{ V}, I_D = -6.2 \text{ A}$		0.028	0.034	Ω				
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -1.8 \text{ V}, I_D = -2.3 \text{ A}$		0.036	0.044					
		V _{GS} = - 1.5 V, I _D = - 1 A		0.050	0.100	1				
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 6.7 A		30		S				
Dynamic ^b				L		l				
Input Capacitance	C _{iss}			1800		pF				
Output Capacitance	C _{oss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		450						
Reverse Transfer Capacitance	C _{rss}			390						
Tatal Cata Chausa		$V_{DS} = -6 \text{ V}, V_{GS} = -8 \text{ V}, I_D = -10 \text{ A}$		38	57	nC				
Total Gate Charge	Qg			23	35					
Gate-Source Charge	Q_{gs}	$V_{DS} = -6 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -10 \text{ A}$		3						
Gate-Drain Charge	Q_{gd}			6.5						
Gate Resistance	R_g	f = 1 MHz		7		Ω				
Turn-On Delay Time	t _{d(on)}			20	30					
Rise Time	t _r	V_{DD} = - 6 V, R_L = 0.75 Ω		40	60					
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ - 8 A, $V_{GEN}=$ - 4.5 V, $R_g=$ 1 Ω		65	100					
Fall Time	t _f			40	60					
Turn-On Delay Time	t _{d(on)}			10	15	ns				
Rise Time	t _r	V_{DD} = - 6 V, R_L = 0.75 Ω		12	20	- - -				
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ - 8 A, V_{GEN} = - 8 V, R_g = 1 Ω		70	105					
Fall Time	t _f			40	60					
Drain-Source Body Diode Characteristics										
Continuous Source-Drain Diode Current	I _S	$T_C = 25 ^{\circ}C$			- 12	Α				
Pulse Diode Forward Current	I _{SM}				40	^				
Body Diode Voltage		I _S = -8 A, V _{GS} = 0 V		- 0.8	- 1.2	V				
Body Diode Reverse Recovery Time	t _{rr}			40	60	ns				
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 8 A, di/dt = 100 A/μs, T _{.1} = 25 °C		20	30	nC				
Reverse Recovery Fall Time	t _a	$I_F = -0$ A, $U_1/U_1 = 100$ A/ μ s, $I_J = 25$ °C		14		no				
Reverse Recovery Rise Time	t _b			26		ns				

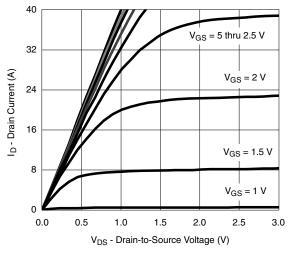
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

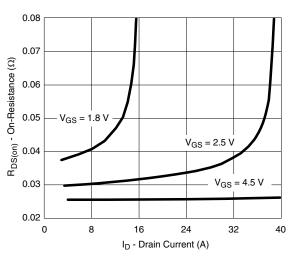
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



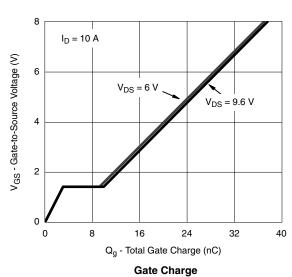
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

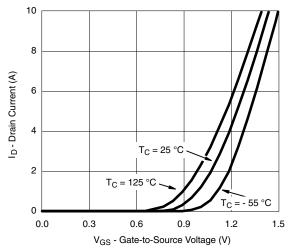


Output Characteristics

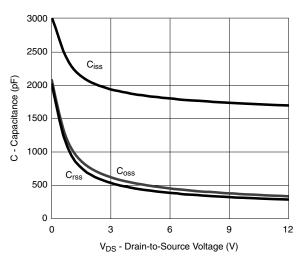


On-Resistance vs. Drain Current and Gate Voltage

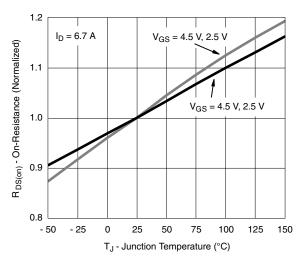




Transfer Characteristics

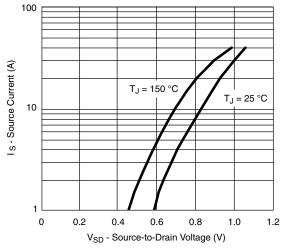


Capacitance

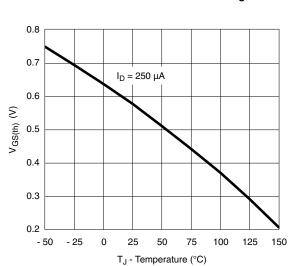


On-Resistance vs. Junction Temperature

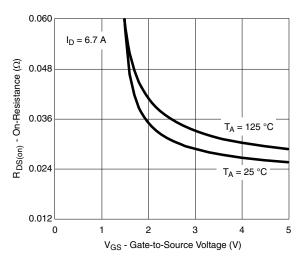
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



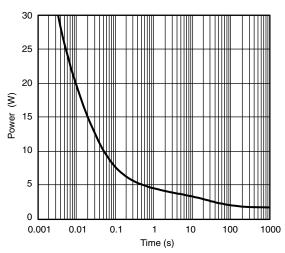
Soure-Drain Diode Forward Voltage



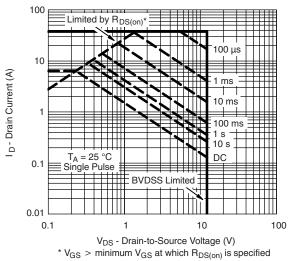
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



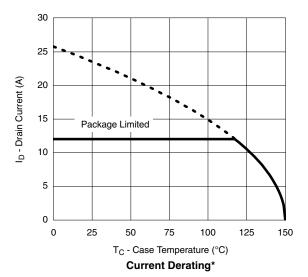
Safe Operating Area, Junction-to-Ambient

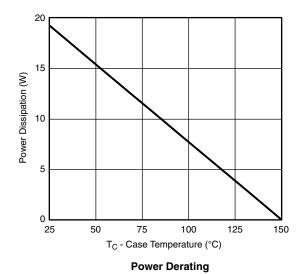






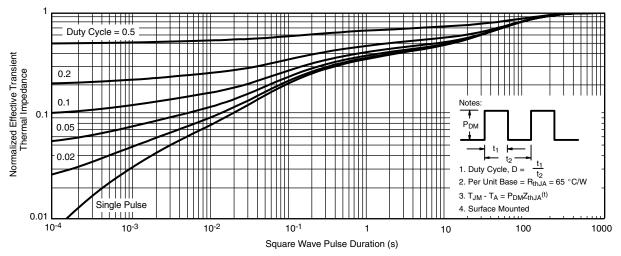
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



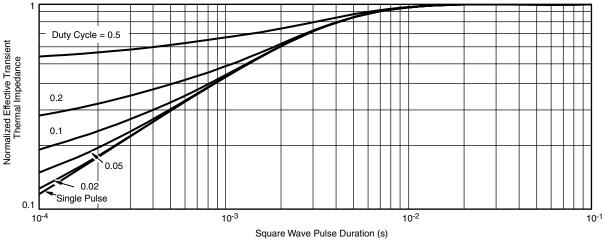


 $^{^{\}star}$ The power dissipation P_D is based on T_{J(max.)} = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



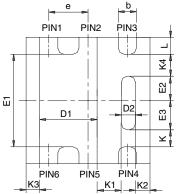
Normalized Thermal Transient Impedance, Junction-to-Case

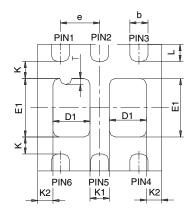
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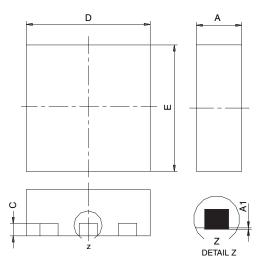
PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
 Package outline exclusive of mold flash and metal burr
 Package outline inclusive of plating

			SINGL	E PAD		DUAL PAD						
DIM	M	ILLIMETER	RS		INCHES		М	MILLIMETERS			INCHES	
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A 1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D2	0.135	0.235	0.335	0.005	0.009	0.013						
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E2	0.345	0.395	0.445	0.014	0.016	0.018						
E3	0.425	0.475	0.525	0.017	0.019	0.021						
е		0.65 BSC			0.026 BSC	;	0.65 BSC			0.026 BSC		
K		0.275 TYP			0.011 TYP	1	0.275 TYP		0.011 TYP			
K1		0.400 TYP			0.016 TYP		0.320 TYP		0.013 TYP			
K2		0.240 TYP		0.009 TYP		0.252 TYP		0.010 TYP				
К3		0.225 TYP		0.009 TYP								
K4		0.355 TYP		0.014 TYP								
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
Т							0.05	0.10	0.15	0.002	0.004	0.006
ECN: C O	2.07/21 Pay C 06 Aug 07											

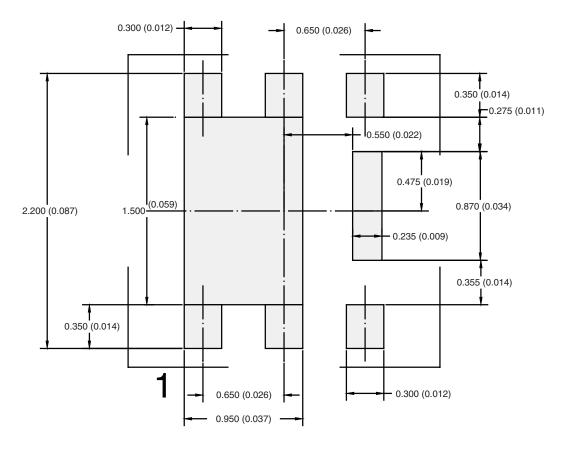
ECN: C-07431 - Rev. C, 06-Aug-07

DWG: 5934

Document Number: 73001 06-Aug-07



RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single



Dimensions in mm/(Inches)

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Revision: 02-Oct-12 Document Number: 91000